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General information regarding the model and parameter TEMP

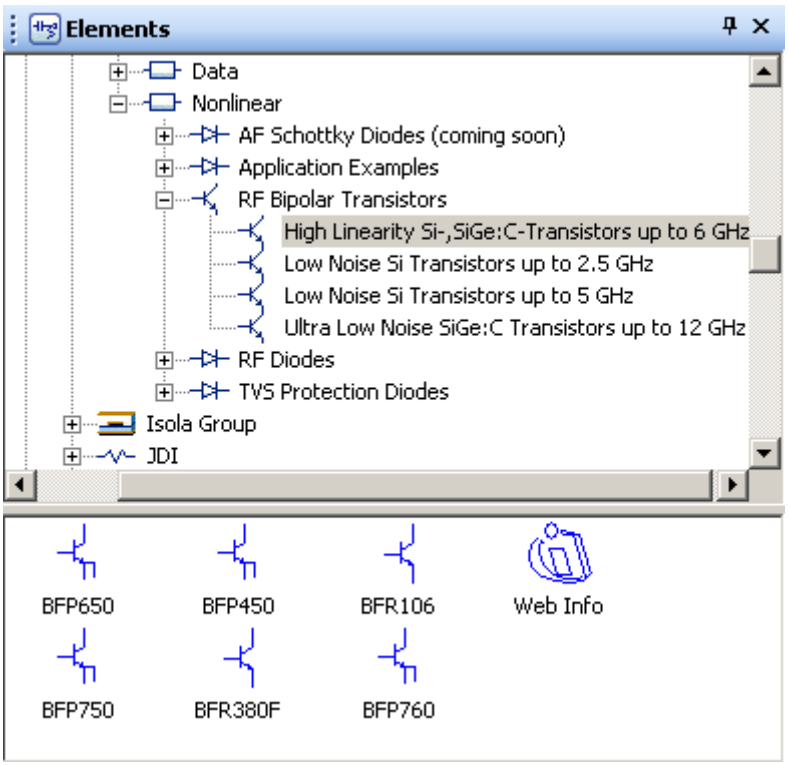
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************************************************************

*      Infineon     Technologies AG
*      GUMMEL-POON  MODEL  IN     SPICE  2G6    SYNTAX
*      VALID  UP    TO     6      GHZ
*      >>>    BFP410 <<<
*      (C)    2014   Infineon     Technologies AG
*      Version      3.0    November     2014

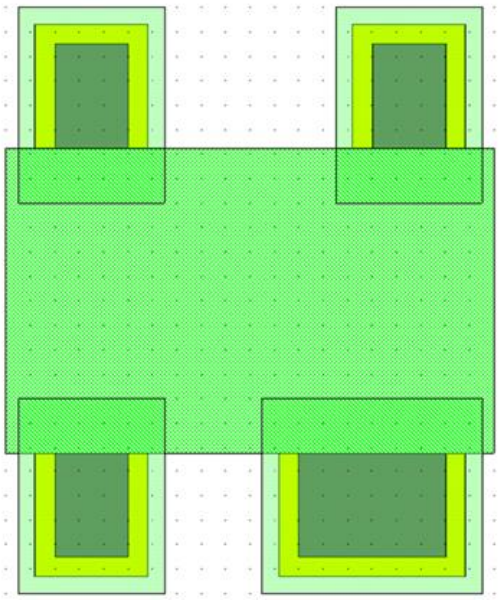
************************************************************
* - Please use the global SPICE GP parameter TEMP to specify the
*     junction temperature of the device in your application to get
*     correct simulation results. This procedure is necessary because
*     the GP model does not consider the self heating of the device.
* - TEMP is calculated by TEMP=TA+Pdc*(RthJS+RthSA). The junction
*   temperature TEMP is the sum of the ambient temperature TA and
*   the increment of temperature caused by the dissipated DC power Pdc.
* - RthJS is the thermal resistance between the junction and the
*   soldering point. RthJS for this device is 335 K/W. RthSA is the
*   thermal resistance of the PCB, from the soldering point to the
*   ambient. For determination of RthSA please refer to Infineon's
*   Application Note "Thermal Resistance Calculation" AN077.
* - The model has been verified in the junction temperature range
*   -25°C to +125°C.
* - TNOM=25 °C is the nominal ambient temperature during measurement
*   for the parameter extraction. Please do not change this value.
************************************************************
```

Infineon library with models of RF transistors in MWO (Microwave Office from AWR)

Infineon offers in MWO a library containing actual spice models of RF transistors. The library is grouped in 4 categories in dependence on application.



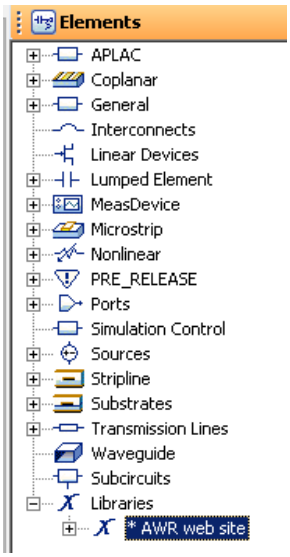
The library contents also ready to use package layouts to simplify designing of PCB.



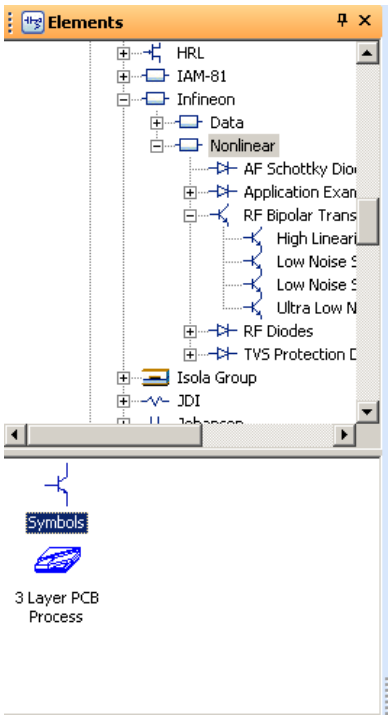
Import of symbols in library of MWO

By start-up of MWO there are some symbols of Infineon products missing. You can change it in few steps:

1. In “Elements” please choose “Libraries” and then “*AWR web site”.



2. In “*AWR web site” please open “Parts by Vendor” then Infineon and “Nonlinear”.
3. Please do right click on “Symbols”.

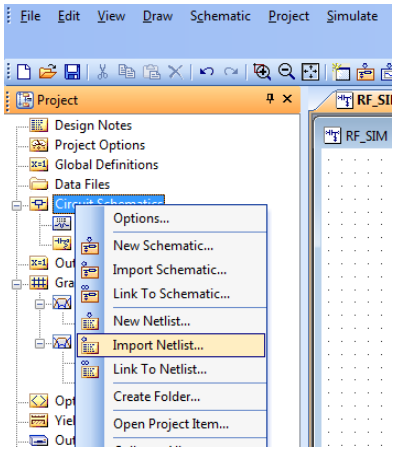


4. Please click on “Element Help…” and download the necessary data.
5. After you extract the archive please copy infineon_32.syf to <AWR Installation Folder>\Symbols to currently used MWO installation.
6. Restart the MWO Design Environment to see the effect of added symbols for Infineon library elements.

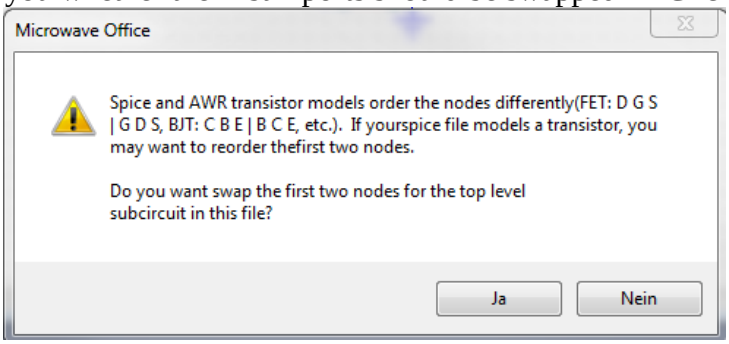
Import SPICE-Model in MWO

Following steps are required in order to import a SPICE-netlist with the corresponding symbol view for the transistor:

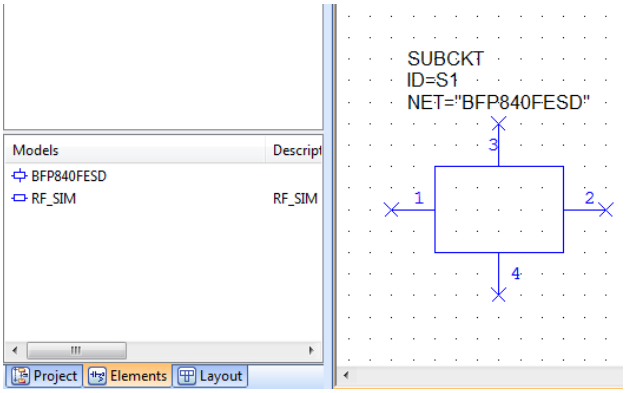
- Open the working project where you want to embed the transistor in your main schematic
- Import the netlist (e.g.: BFP410_spice_v3.txt) by right mouse click on **Circuit Schematics**, then select **Import Netlist** and go to the folder where the netlist (e.g.: BFP410_spice_v3.txt) was stored and select the file.



- A new window is popped up. Choose the **Pspice** netlist format and click ok.
- MWO will ask you whether the first 2 ports should be swapped → Click **yes**

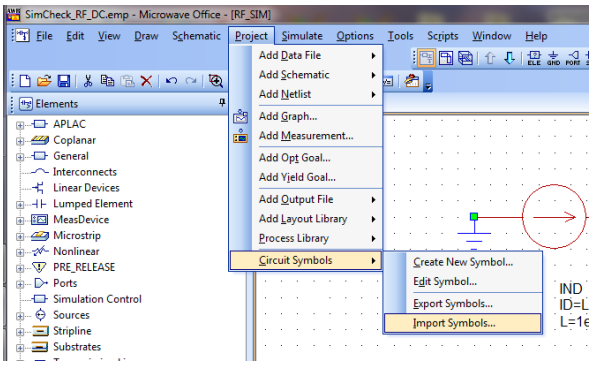


The netlist is now accessible within the elements in "Subcircuits". Simply drag and place with the mouse the wanted element to your main schematic.

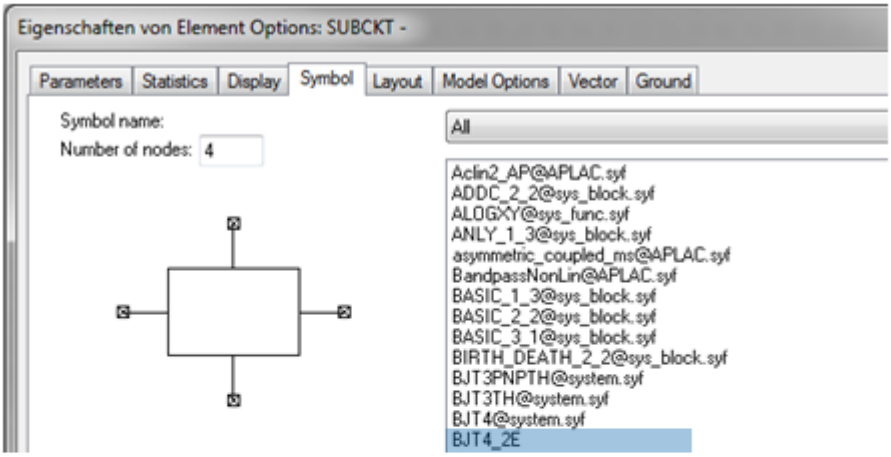


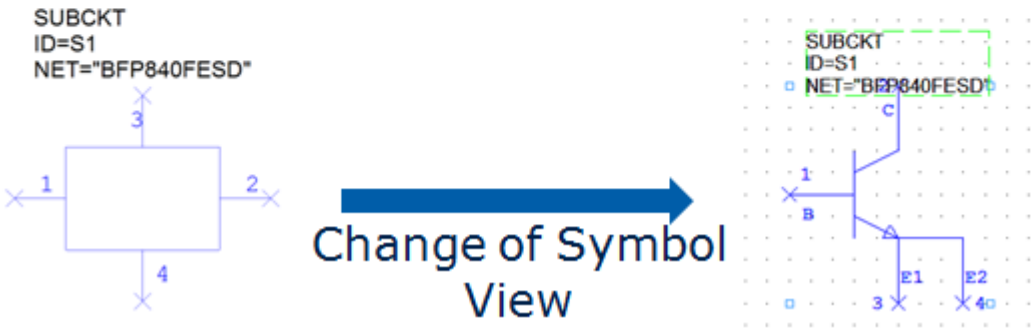
The netlist is still represented by the unwanted default 4-port box representation.

- Import the appropriate symbol for this device which has two emitter pads (**Project → Circuit Symbols → Import Symbols**)
-



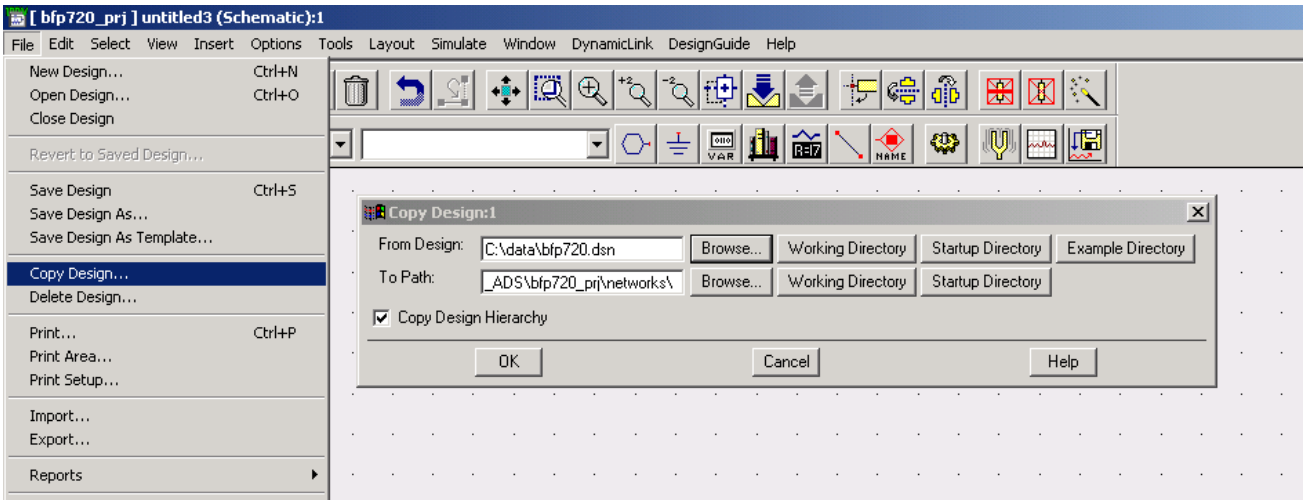
- The correct symbol must now be linked to the transistor subcircuit. This is achieved by right click on BFP410 and select "properties". New window is popped up. Now link the symbol BJT_2E to the subcircuit of the transistor.





Import SPICE-Model in ADS version 2009 (Advanced Design System from Agilent)

To import the SPICE-Model in ADS 2009 the following procedure is to be done:
Store both ADS-files (*.dsn and *.ael) in one folder. In a schematic window of ADS go to ->File -> Copy Design… Then set the path of the folder where the ADS-files of the device have been stored and select the *.dsn file (the *.ael file will be automatically imported). Set also the path of your current project. Then click OK.



Import SPICE-Model in ADS version 2011 (Advanced Design System from Agilent)

To import the SPICE-Model in ADS version 2011 the following procedure is to be done:
Copy the extracted ADS folder (e.g.: “BFP410”) to your actual workspace “*workspacename*_ wrk” under the subfolder “*workspacename*_lib”. After that you can place the model into your design for simulation.